# imall

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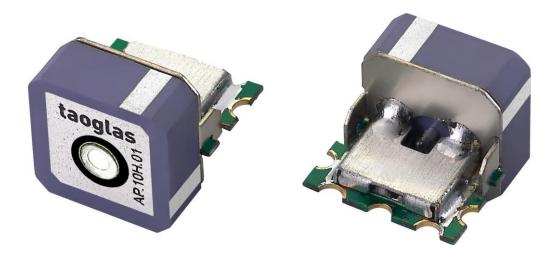
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# **SPECIFICATION**

- Part No. : AP.10H.01
- Product Name : 10mm SMT 25dB Active GPS/GALILEO Patch Antenna With Front End Saw Filter
- Features : Unique SMT GPS/GALILEO active patch Wide Input Voltage 1.8V to 5.5V Ultra low power consumption RoHS compliant





#### **1. Introduction**

The AP.10H.01 two stage 25dB active GPS patch antenna is the smallest SMT GPS high performance embedded antenna currently available in the world. Using extremely sensitive high dielectric constant powder formulation and tight process control the 10mm x 10mm x 4mm patch antenna is accurately tuned to have its frequency band right at 1575.42MHz for GPS/GALILEO systems.

A patented SMT structure gives high reliability in integration. With an ultra low power consumption two stage LNA with Saw Filter, this small active patch has the performance of an ordinary active patch, but at only a quarter of the size. This product is suited to small form factor mobile devices such as GPS/GALILEO Smartphones, Personal Location, Medical devices, Telematic devices and Automotive navigation and tracking. Custom gain, connector and cable versions are available.

The AP.10H consists of 2 functional blocks – the LNA and also the patch antenna.



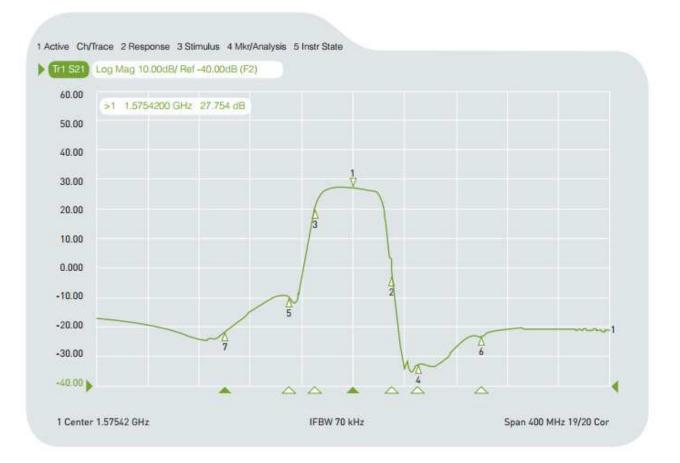


### 2. Specification

ELECTRICAL					
Frequency	1575.42 ± 1.023MHz				
Gain	Typ10dBic @ Zenith				
Gain@3.0V (With LNA)		15 ± 4dBic @ 90°			
Impedance		<b>50</b> Ω			
Polarization		RHCP			
Axial Ratio		Max 4.0dB @ Zenith			
Input Voltage		Min. 1.8V, Typ. 3.0V, Max. 5.5	5V		
ESD Capability		Direct Discharge: 4KV Min.			
		LNA			
Frequency		1575.42 ± 1.023MHz			
		F0=1575.42MHz			
Outer Band Attenuation	F0±30MHz 5dB min.				
outer build Accondition	F0±50MHz 20dB min.				
	F0±100MHz 25dB min.				
Output Impedance	50Ω				
Output VSWR	2.0 Max				
Pout at 1dB Gain	Min. 8dBm				
Compression point	Typ. 11dBm				
 	LNA Gain, Power Consumption and Noise Figure				
	LNA Gain(Typ)	Power Consumption(mA)Typ	Noise Figure(Typ)		
Minimum 1.8V	20dB	5mA	2.7dB		
Typical 3.0V	25dB 10mA 2.5dB		2.5dB		
Maximum 5.5V	25dB 23mA 2.7dB		2.7dB		
Input Voltage	Min. 1.8V Typ. 3.0V Max. 5.5V				
		CHANICAL			
Dimension	10mm x 10mm x 4mm (add 7.3mm depth for vertical PCB)				
Connection	SMT via solder pads				
	ENVIRONMENTAL				
Operation Temperature	-40°C to + 85°C				
Storage Temperature	-40°C to + 85°C				
Relative Humidity	40% to 95%				



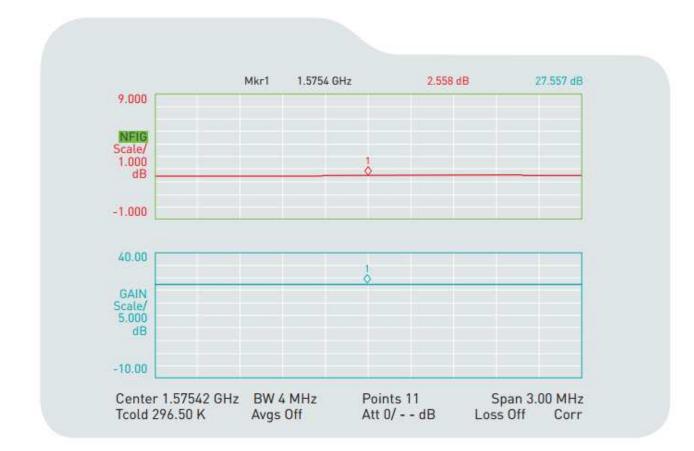
### **3. LNA Gain and Out Band Rejection @3.0V**



Cg1 Tr1 S21	>1	1.5754200 GHz	27.754	dB	
Cg1 Tr1 S21	2	1.6054200 GHz	- 2.2291	dB	
Cg1 Tr1 S21	3	1.5454200 GHz	20.458	dB	
Cg1 Tr1 S21	4	1.6254200 GHz	- 32.691	dB	
Cg1 Tr1 S21	5	1.5254200 GHz	- 10.283	dB	
Cg1 Tr1 S21	6	1.6754200 GHz	- 23.132	dB	
Cg1 Tr1 S21	7	1.4754200 GHz	- 21.485	dB	

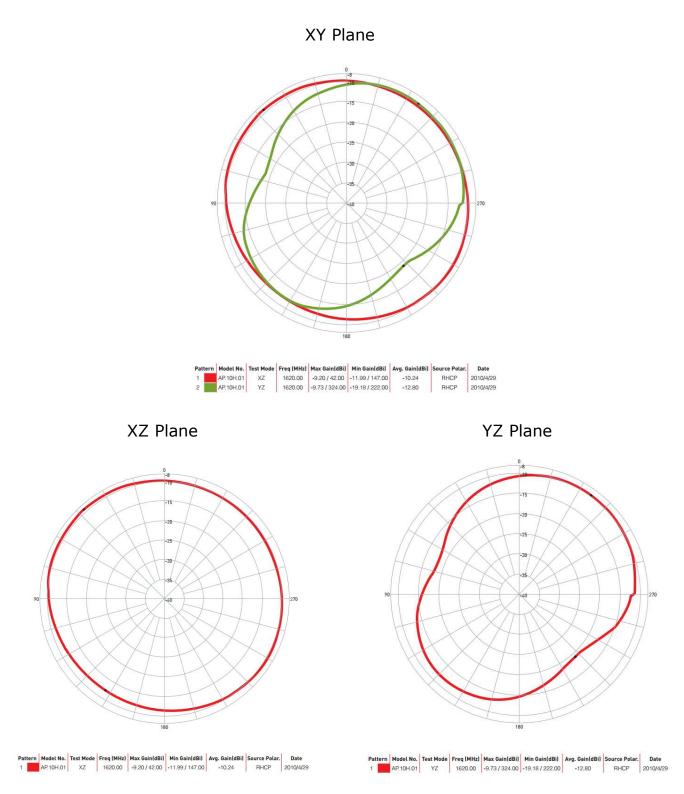


#### 4. LNA Noise Figure @3.0V



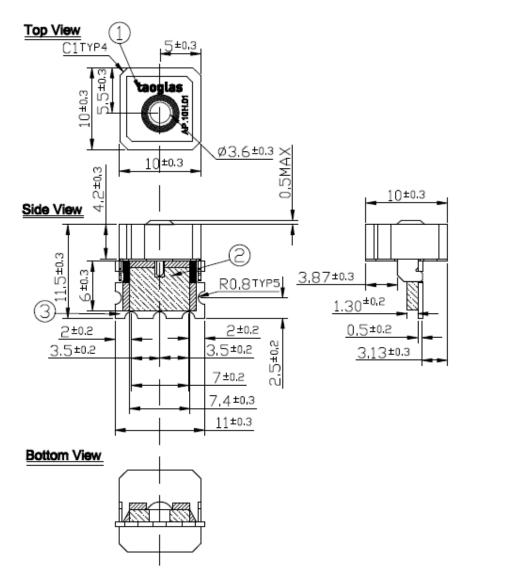


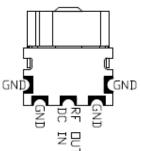
#### **5. Radiation Patterns**





#### 6. Technical Drawing

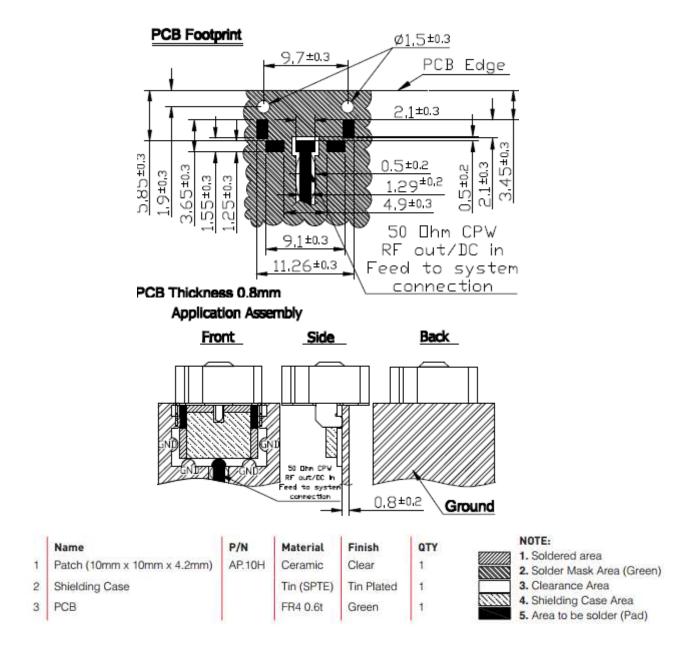




	Name	P/N	Material	Finish	QTY		NOTE: 1. Soldered area
1	Patch (10mm x 10mm x 4.2mm)	AP.10H	Ceramic	Clear	1		2. Solder Mask Area (Green)
2	Shielding Case		Tin (SPTE)	Tin Plated	1		3. Clearance Area
3	PCB		FR4 0.6t	Green	1	HIIH	<ol> <li>Shielding Case Area</li> <li>Area to be solder (Pad)</li> </ol>



#### **6.1. PCB Footprint**

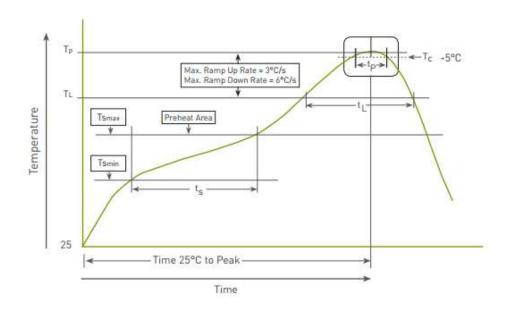




#### **7. Recommended Reflow Soldering Profile**

AP.10H can be assembled following Pb-free assembly. According to the Standard IPC/JEDEC J-STD-020C, the temperature profile suggested is as follows:

Phase	Profile Features	Pb-Free Assembly (SnAgCu)
PREHEAT	Temperature Min(Tsmin)	150°C
	Temperature Max(Tsmax)	200°C
	Time(ts) from (Tsmin to Tsmax)	60-120 seconds
RAMP-UP	Avg. Ramp-up Rate (Tsmax to TP)	3°C/second(max)
REFLOW	Temperature(TL)	217°C
	Total Time above TL (tL)	30-100 seconds
PEAK	Temperature (TP)	260°C
	Time (tp)	2-5 seconds
RAMP-DOWN	Rate	3°C/second(max)
Time from 25°C to Peak Temperature		8 minutes max.
Composition of solder paste		96.5Sn/3Ag/0.5Cu
Solder Paste Model		SHENMAO PF606-P26

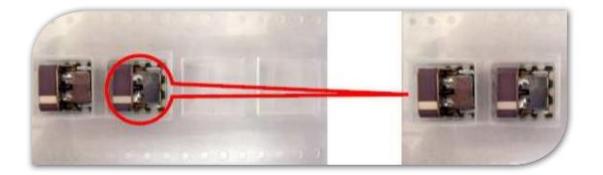


The graphic shows temperature profile for component assembly process in reflow ovens

Soldering Iron condition: Soldering iron temperature 270°C±10°C. Apply preheating at 120°C for 2-3 minutes. Finish soldering for each terminal within 3 seconds, if soldering iron temperature over 270°C±10°C or 3 seconds, it will make cause component surface peeling or damage.



#### 8. Packaging



Packaged on Tape and Reel Each Reel is packaged Outer Carton contains 5 Reels 250 pieces per reel Inner Carton 1250 pieces per Carton

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